

Package : HTSSOP-A

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1. Structure and materials

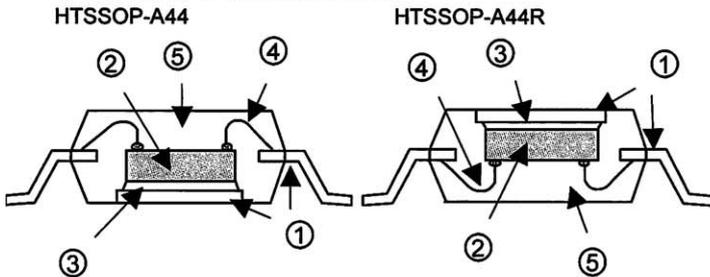


Fig. 1 Structure

No.	Item	Materials
①	Lead Frame	Cu-Alloy (External lead : Pb free solder plating)
②	Die	Silicon
③	Die Attach	Ag paste
④	Wire	Cu
⑤	Molding	Epoxy Resin

2. Tape and Reel information

2. 1. Packing specification

Tape	Embossed carrier tape(with dry pack)
Quantity	See the table on page 4/4
Direction of feed	E2 (See Fig. 2)

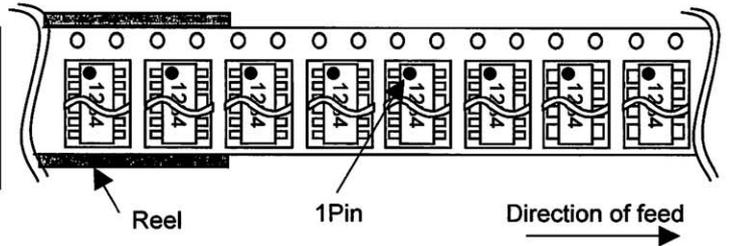


Fig. 2 Typical Tape and Reel configuration

2. 2. Tape and Reel specification

2. 2. 1. Tape and reel dimensions (See the table on page 4/4)

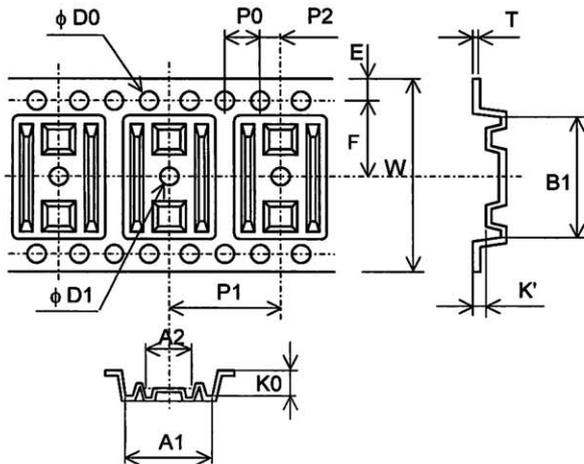


Fig. 3 Tape dimensions

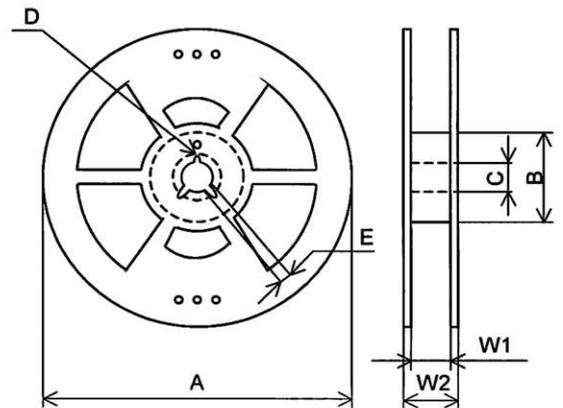


Fig. 4 Reel dimensions

2. 3. Leader and Trailer

2. 3. 1. Leader

No component pockets are 40 pockets or more.

2. 3. 2. Trailer

No component pockets are 10 pockets or more.

Tape is free from reel.

2. 4. Label for Reel and Box

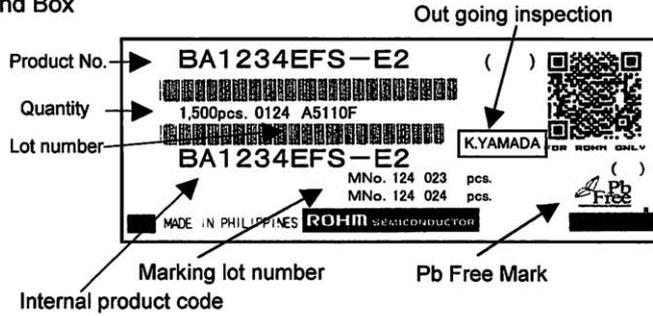


Fig. 5 Label example

2. 5. Packing style

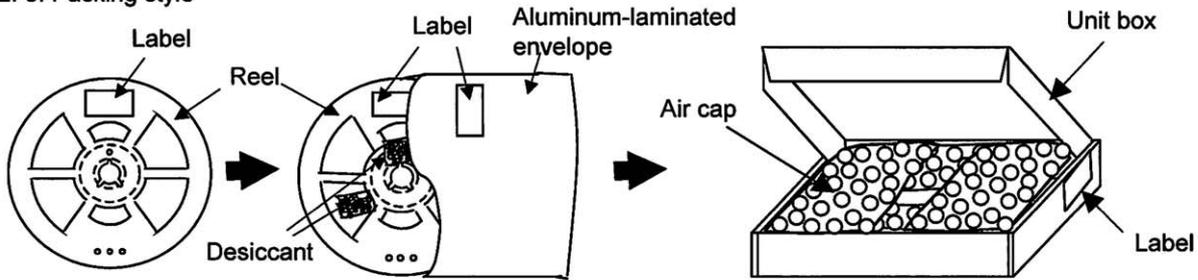
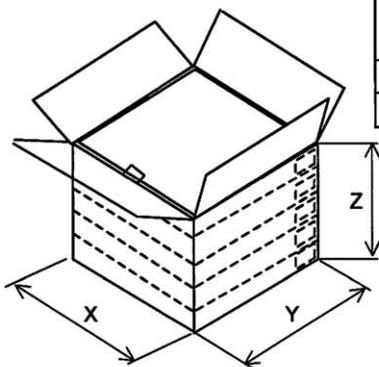


Fig. 6 Packing style

2. 6. Shipping style

5 unit boxes or less per shipping box



Package	box dimensions (all dimensions in mm)		
	X	Y	Z
HTSSOP-A44	372	368	355
HTSSOP-A44R	372	368	355

2. 7. Packing materials

Item	Material
Embossed carrier tape	PS
Cover tape	PET + PE
Reel	PS
Desiccant	Silicagel
Envelope	Aluminume-laminated
Air cap	Polyethylene
Unit box	Cardboard
Shipping box	Cardboard

*Please obey the indication of top side in a shipping box.

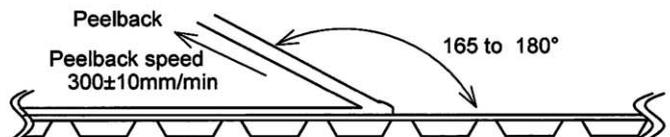
Fig. 7 Shipping box dimensions and Shipping style

2. 8. Others

2. 8. 1. Peelback strength

Cover tape peelback strength is 0.2 to 0.7N.

Fig. 8 Test method



2. 8. 2. Missing lcs

- (1) No consecutive dropouts.
- (2) A maximum 0.1% of specified number of products in each packing may be missing.

3. Storage conditions

3. 1. Storage environment

Recommended storage conditions are as follows :

- Temperature : 5 to 30°C
- Humidity : 40 to 70% RH

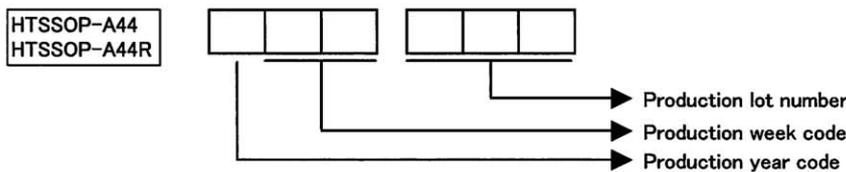
3. 2. Storage period

-Specified storage period : 1 year

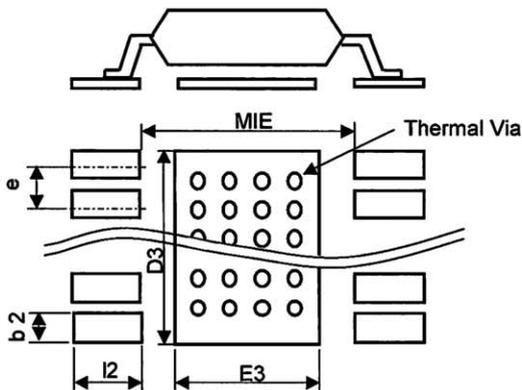
3. 3. Specified storage period until soldering

After dry pack is opened , assemble package within 168hours.
 If the storage period has expired , the products must be baked 125°C for 24hours.
 Maximum 2times baking for keeping solderability.
 Execute baking by 60°C/48hours while put in the embossed tape.

4. Marking lot number



5. Footprint dimensions (Optimize footprint dimensions to the board design and soldering condition)



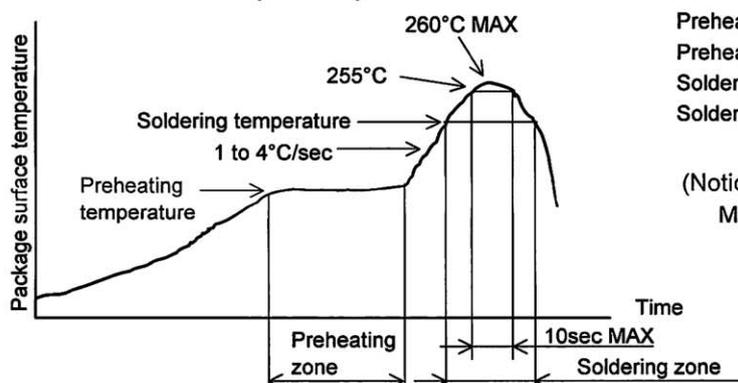
(all dimensions in mm)

Package	Land pitch e	Land space MIE	Land length ≥ I2	Land width b2
HTSSOP-A44	0.80	7.70	1.20	0.50
HTSSOP-A44R	0.80	7.70	1.20	0.50

Package	Radiation land length D3	Radiation land width E3	Thermal via	
			Pitch	Diameter
HTSSOP-A44	18.50	6.70	1.20	φ0.3
HTSSOP-A44R	-	-	-	-

6. Soldering conditions

6. 1. Recommended temperature profile for reflow



- Preheating temperature ; 130°C to 190°C
- Preheating zone ; 120sec MAX
- Soldering temperature ; 220°C to 230°C
- Soldering zone ; 60sec MAX

(Notice)
 Maximum 2-times soldering

6. 2. Recommended condition for wave soldering

Process	Conditions	
	Temperature	Time
Preheating	120°C to 150°C	60sec MAX
Soldering	260°C ± 3°C	12sec MAX

(Notice) Soldering time is provided for total soldering time in case of dual wave soldering.

6. 2. 1. Notes for wave soldering

- (1) The heatsink may not be connected using wave soldering methods.
Solder can stick to the exposed pad on HTSSOP-A44R.
- (2) Do not use other soldering methods with wave soldering.
- (3) Recommend to clean the board to eliminate flux, solder waste, and other impurities for reliability, after soldering.
- (4) Optimize soldering condition to prevent solder bridging.

6. 3. Recommended condition for solder iron

Recommended condition for solder iron

-Solder iron temperature : 380°C or less

-Mounting time : 4sec or less

(Notice) The heatsink may not be connected using solder iron.

< Tape dimensions >

Package	Quantity (pcs)	Tape dimensions (all dimensions in mm)													
		A1	A2	B1	D0	D1	E	F	K'	K0	P1	P2	T	W	P0
HTSSOP-A44	1500	10.2	7.29	19.1	φ1.5	φ2.0	1.75	14.2	0.85	1.5	12.0	2.0	0.3	32.0	4.0
HTSSOP-A44R	1500	10.2	7.29	19.1	φ1.5	φ2.0	1.75	14.2	0.85	1.5	12.0	2.0	0.3	32.0	4.0
Tolerance		±0.1	±0.05	±0.1	+0.1 -0	+0.1 -0	±0.1	±0.1	±0.05	±0.1	±0.1	±0.1	±0.05	±0.3	±0.1

< Reel dimensions >

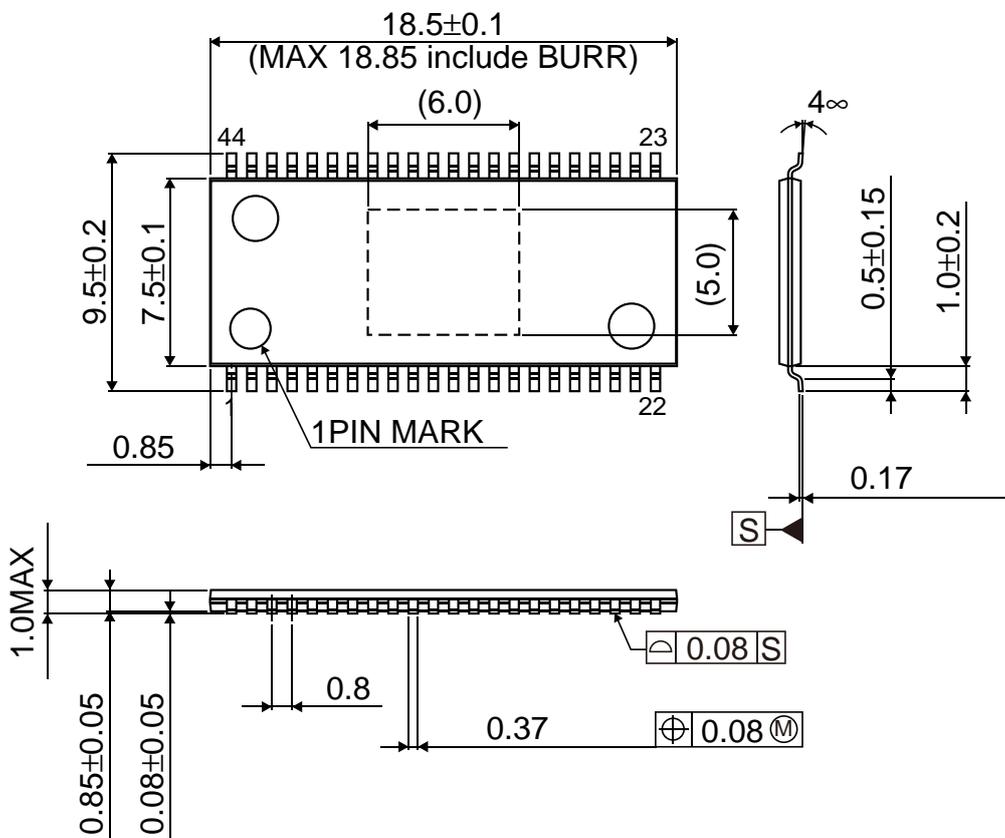
Package	Reel dimensions (all dimensions in mm)						
	A	B	C	D	E	W1	W2
HTSSOP-A44	φ330	φ100	φ13.0	φ20.2	1.5	33.5	38.5
HTSSOP-A44R	φ330	φ100	φ13.0	φ20.2	1.5	33.5	38.5
Tolerance	-	-	±0.2	MIN	MIN	±1.0	MAX

< Dehydrated weight >

Dehydrated weight dimensions in g
0.32
0.32

Package Dimensions

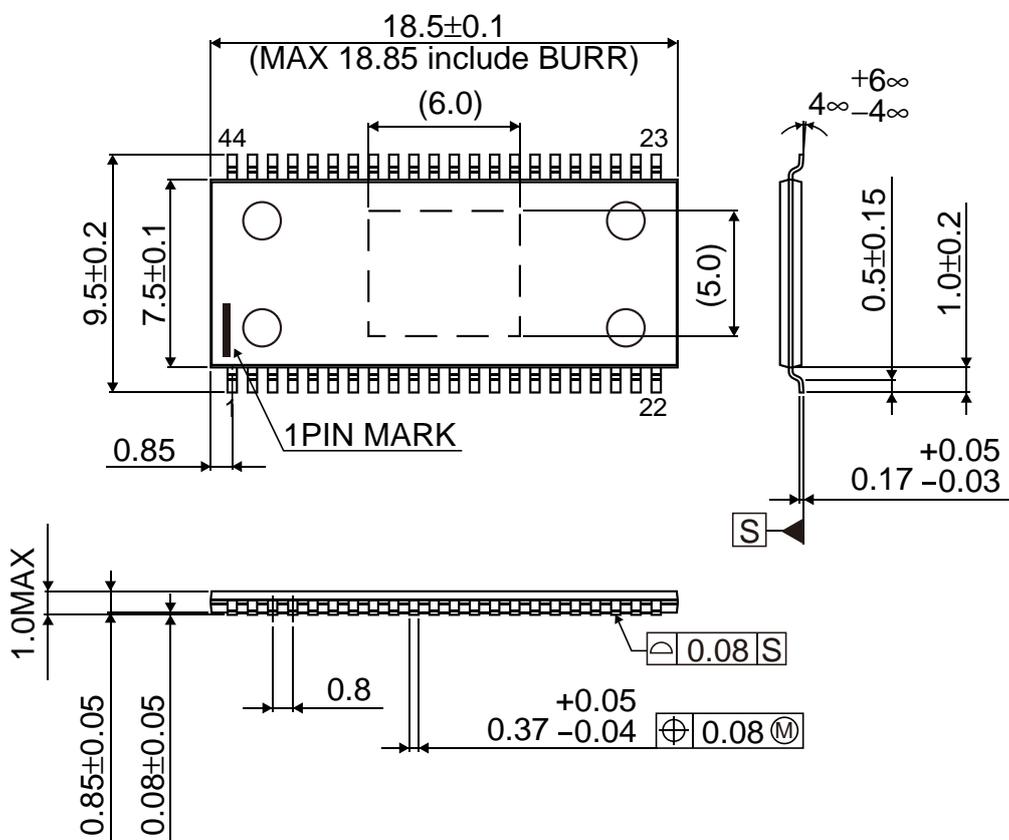
HTSSOP-A44



(Unit : mm)

Package Dimensions

HTSSOP-A44R



(Unit : mm)

Notes

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